

C0805J333K1RACTU

Aliases (C0805J333K1RAC7800) SMD Comm X7R FO, Ceramic, 0.033 uF, 10%, 100 VDC, X7R, SMD, MLCC, Open Mode, Temperature Stable, 0805, 0.6 mm



General Information	
Series	SMD Comm X7R FO
Style	SMD Chip
Description	SMD, MLCC, Open Mode, Temperature Stable
Features	Open Mode, Temperature Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	21 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	0805
L	2mm +/-0.3mm
W	1.25mm +/-0.3mm
т	1.25mm +/-0.15mm
S	0.6mm MIN
В	0.5mm +/-0.25mm

Packaging Specifications

PackagingT&R, 1Packaging Quantity2500

T&R, 180mm, Plastic Tape 2500

Specifications	
Capacitance	0.033 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	100 VDC
Dielectric Withstanding Voltage	250 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5%1kHz1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	30.303 GOhms

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